



## NOTE:

- This data is supplied for general information only and is believed to be correct at the time of publication.
- For critical applications, the customer is advised to verify device revision and pad coordinates, prior to processing
- Changes can be made without notification from the manufacturer. Silicon Supplies Ltd cannot accept liability in that event

DEVICE	AM2359P (IRFC9014)	DIE SIZE UNSAWN (MILS)	31.42 X 30 X 6
MANUFACTURER	ANALOG POWER	BOND PADS (MILS)	5.12 X 5.12
APPROVED BY	GEW	TOP METAL	Al
DATE	25/02/21	BACK METAL	Ti/Ni/Ag
SERIAL NUMBER	0926	BACK POTENTIAL	DRAIN

